TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74VCX16244FT**

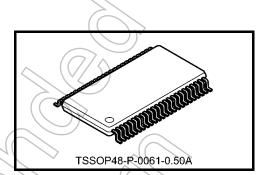
Low-Voltage 16-Bit Bus Buffer with 3.6-V Tolerant Inputs and Outputs

The TC74VCX16244FT is a high-performance CMOS 16-bit bus buffer. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is also designed with overvoltage tolerant inputs and outputs up to  $3.6\ V\!.$ 

This device is non-inverting 3-state buffer having four active-low output enables. It can be used as four 4-bit buffers or two 8-bit buffers or one 16-bit buffer. When the  $\overline{OE}$  input is high, the outputs are in a high impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.25 g (typ.)

#### **Features**

- Low-voltage operation: V<sub>CC</sub> = 1.8 to 3.6 V
- High-speed operation:  $t_{pd} = 2.5 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$

:  $t_{pd} = 3.0 \text{ ns (max)} (V_{CC} = 2.3 \text{ to } 2.7 \text{ V})$ 

:  $t_{pd} = 5.0 \text{ ns (max) (V}_{CC} = 1.8 \text{ V})$ 

• Output current:  $I_{OH}/I_{OL} = \pm 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$ 

 $: I_{OH}/I_{OL} = \pm 18 \text{ mA (min)} (V_{CC} = 2.3 \text{ V})$ 

:  $I_{OH}/I_{OL} = \pm 6 \text{ mA (min) (V}_{CC} = 1.8 \text{ V)}$ 

- Latch-up performance: -300 mA
- ESD performance: Machine model ≥ ±200 V

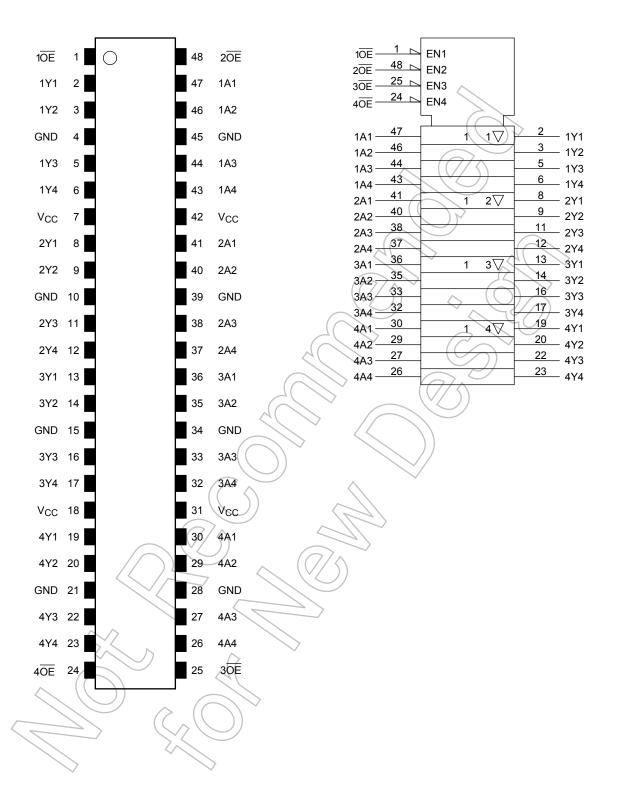
Human body model ≥ ±2000 V

- Package: TSSOP
- 3.6-V tolerant function and power down protection provided on all inputs and outputs



### Pin Assignment (top view)

### **IEC Logic Symbol**



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# **Truth Table**

Inp	Outputs	
1 <del>OE</del>	1A1-1A4	1Y1-1Y4
L	L	L
L	Н	Н
Н	Х	Z

Inp	Outputs	
2 <del>OE</del>	2A1-2A4	2Y1-2Y4
L	L	L
L	Н	Н
Н	Х	Z

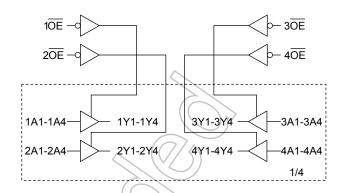
Inp	Outputs	
3 <del>OE</del>	3A1-3A4	3Y1-3Y4
L	L	L
L	Н	Н
Н	Х	Z

Inp	Outputs	
4OE	4A1-4A4	4Y1-4Y4
L	L	L
L	Н	Н
Н	Х	z

X: Don't care

Z: High impedance

# System Diagram



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### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	$V_{CC}$	-0.5 to 4.6	V	
DC input voltage	V <sub>IN</sub>	-0.5 to 4.6	V	
		-0.5 to 4.6 (Note 2)	V	
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)		
Input diode current	l <sub>IK</sub>	-50	mA	
Output diode current	I <sub>OK</sub>	±50 (Note 4)	mA	
DC output current	lout	±50 <	mA (/	
Power dissipation	$P_{D}$	400	mW	
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA	
Storage temperature	T <sub>stg</sub>	-65 to 150	~c)	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

## **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	<b>V</b> cc	1.8 to 3.6 1.2 to 3.6 (Note 2)	V	
Input voltage	VIN	-0.3 to 3.6	V	
Output voltage		0 to 3.6 (Note 3)	V	
Output voltage	Vout	0 to V <sub>CC</sub> (Note 4)	V	
<u> </u>		±24 (Note 5)		
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±18 (Note 6)	mA	
	$\wedge$	±6 (Note 7)		
Operating temperature	Topr	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 8)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 2: Data retention only

Note 3: OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$ 

Note 7:  $V_{CC} = 1.8 \text{ V}$ 

Note 8:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



### **Electrical Characteristics**

# DC Characteristics (Ta = -40 to $85^{\circ}$ C, 2.7 V < V<sub>CC</sub> $\leq 3.6$ V)

Character	stics	Symbol	Test Co	ondition	V <sub>CC</sub> (V)	Min	Max	Unit
Input voltage	H-level	V <sub>IH</sub>	_	_	2.7 to 3.6	2.0	_	V
iliput voltage	L-level	V <sub>IL</sub>	_	_	2.7 to 3.6	_	0.8	V
			I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	_		
	H-level	Voh	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -12 mA	2.7	2.2	_	
				I <sub>OH</sub> = -18 mA	3.0	2.4	_	
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_	V
		level V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 100 \mu\text{A}$	2.7 to 3.6		0.2	
	L-level			I <sub>OL</sub> = 12 mA	2.7	4	0.4	
	L-ICVCI			I <sub>OL</sub> = 18 mA	3.0	2	0.4	
				$I_{OL} = 24 \text{ mA}$	3.0	D) <del>-</del>	0.55	
Input leakage curre	nt	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		2.7 to 3.6	4	±5.0	μΑ
3-state output OFF	state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 3.6 V		2.7 to 3.6	>_	±10.0	μА
Power-off leakage	current	loff	$V_{IN}$ , $V_{OUT} = 0$ to 3.6 V		) (0)	_	10.0	μА
Quiescent supply c	urrent	loo	$V_{IN} = V_{CC}$ or GND		2.7 to 3.6	_	20.0	
Quiescent supply current		Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$ 2.7 to 3.6		_	±20.0	μΑ	
Increase in I <sub>CC</sub> per	input	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6	_	750	

# DC Characteristics (Ta = -40 to 85°C, 2.3 V ≤ V<sub>CC</sub> ≤ 2.7 V)

Characteris	itics	Symbol	Test Co	pndition	V <sub>CC</sub> (V)	Min	Max	Unit
Input voltage	H-level	ViH			2.3 to 2.7	1.6	_	V
input voitage	L-level	VIL		)	2.3 to 2.7	_	0.7	V
		>		I <sub>OH</sub> = -100 μA	2.3 to 2.7	V <sub>CC</sub> - 0.2	_	
_	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -6 mA	2.3	2.0	_	
	N 17			I <sub>OH</sub> = -12 mA	2.3	1.8	_	
Output voltage		$\mathcal{A}($	$\mathcal{J}($	$I_{OH} = -18 \text{ mA}$	2.3	1.7	_	V
				I <sub>OL</sub> = 100 μA	2.3 to 2.7	_	0.2	
	L-level	> VOL VI	VIN = VIH or VIL	$I_{OL} = 12 \text{ mA}$	2.3	_	0.4	
	(	100		$I_{OL} = 18 \text{ mA}$	2.3	_	0.6	
Input leakage curren	it	JIN	V <sub>IN</sub> = 0 to 3.6 V		2.3 to 2.7	_	±5.0	μΑ
3-state output OFF s	state current	loz	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$		2.3 to 2.7	_	±10.0	μА
Power-off leakage co	urrent	I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0	_	10.0	μΑ
Ouissant summit summer		loo	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.3 to 2.7	_	20.0	Δ
Quiescent supply cu	HEIR	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6$	5 V	2.3 to 2.7	_	±20.0	μА



### DC Characteristics (Ta = -40 to $85^{\circ}$ C, $1.8 \text{ V} \le \text{V}_{\text{CC}} < 2.3 \text{ V}$ )

Characteris	stics	Symbol	Test Condition		Vac (V)	Min	Max	Unit
					V <sub>CC</sub> (V)			
Input voltage	H-level	V <sub>IH</sub>	_	_	1.8 to 2.3	$^{0.7 imes}$ V <sub>CC</sub>	_	V
input voitage	L-level	V <sub>IL</sub>	_	_	1.8 to 2.3		0.2 × V <sub>CC</sub>	V
	H-level	Voh	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -100 \mu A$	1.8	VCC 0.2		
Output voltage				I <sub>OH</sub> = -6 mA	71.8	1.4		V
	L-level	I V <sub>OL</sub> V <sub>IN</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	1.8		0.2	
	L-level			I <sub>OL</sub> = 6 mA	1.8		0.3	
Input leakage currer	nt	I <sub>IN</sub>	$V_{IN} = 0$ to 3.6 V		1.8		±5.0	μΑ
3-state output OFF s	state current	loz	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$		1.8	(4)	±10.0	μА
Power-off leakage c	urrent	I <sub>OFF</sub>	$V_{IN}$ , $V_{OUT} = 0$ to 3.6 V		0	<u> </u>	> 10.0	μΑ
Quiescent supply cu	ırrent		$V_{IN} = V_{CC}$ or GND		1.8		20.0	Δ
Quiescent supply cu	mem	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6$	V	1.8		±20.0	μА

### AC Characteristics (Ta = -40 to 85°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500$ $\Omega$ ) (Note 1)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
	<b>+</b> /		1.8	1.5	5.0	
Propagation delay time	t <sub>pLH</sub> (	Figure 1, Figure 2	$2.5 \pm 0.2$	1.0	3.0	ns
	ΨHL		$3.3 \pm 0.3$	8.0	2.5	
			1.8	1.5	6.5	
3-state output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	$2.5\pm0.2$	1.0	4.1	ns
	t <sub>pZH</sub>		$3.3 \pm 0.3$	8.0	3.5	
		$\sim (                                   $	1.8	1.5	5.0	
3-state output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	$2.5\pm0.2$	1.0	3.8	ns
	t <sub>pHZ</sub> <		$3.3 \pm 0.3$	8.0	3.5	
Output to output skew			1.8	_	0.5	
		(Note 2)	$2.5\pm0.2$	_	0.5	ns
	tosHL		$3.3 \pm 0.3$	_	0.5	

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Note 1: For C<sub>L</sub> = 50 pF, add approximately 300 ps to the AC maximum specification.

Note 2: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$ 

### Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Тур.	Unit
		V <sub>IH</sub> = 1.8 V, V <sub>IL</sub> = 0 V	(Note)	1.8	0.25	
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V	(Note)	2.5	0.6	V
		V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	(Note)	3.3	8.0	
	V <sub>OLV</sub>	V <sub>IH</sub> = 1.8 V, V <sub>IL</sub> = 0 V	(Note)	1,8	-0.25	
Quiet output minimum dynamic $V_{\hbox{\scriptsize OL}}$		V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V	(Note)	2.5	-0.6	V
		V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	(Note)	3.3	-0.8	
		V <sub>IH</sub> = 1.8 V, V <sub>IL</sub> = 0 V	(Nøte)	1.8	1.5	
Quiet output minimum dynamic V <sub>OH</sub>	V <sub>OHV</sub>	V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V	(Note)	2.5	1.9	V
		V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	(Note)	3.3	2.2	

Note: Parameter guaranteed by design.

### **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>		1.8, 2.5, 3.3	6	pF
Output capacitance	CO		1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	$C_{PD}$	f <sub>IN</sub> = 10 MHz	(Note) 1.8, 2.5, 3.3	20	pF

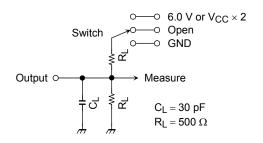
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC \text{ (opr)}} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 



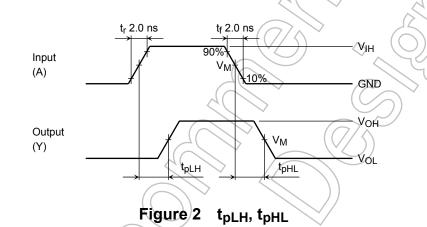
### **AC Test Circuit**



Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
t <sub>pLZ</sub> , t <sub>pZL</sub>	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$		
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND		

Figure 1

### **AC Waveform**



t<sub>r</sub> 2.0 ns t<sub>f</sub> 2.0 ns  $V_{\text{IH}} \\$ Output Enable Control ( $\overline{\mathsf{OE}}$ ) 10% GND  $t_{pLZ}$ 3.0 V or V<sub>CC</sub> Output (Y)  $V_{M}$ Low to Off to Low  $V_{\mathsf{OL}}$  $t_{\text{pHZ}}$  $t_{pZH}$  $V_{\mathsf{OH}}$ Output (Y)  $V_{M}$ High to Off to High - GND Outputs enabled Outputs disabled Outputs enabled

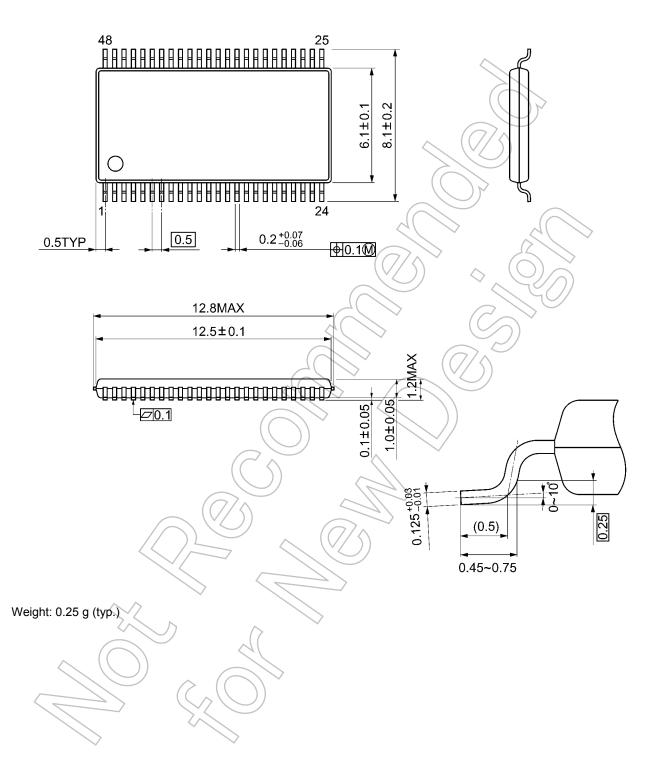
Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

Symbol	Vcc		
	$3.3\pm0.3~\textrm{V}$	2.5 ± 0.2 V	1.8 V
$V_{IH}$	2.7 V	V <sub>CC</sub>	V <sub>CC</sub>
V <sub>M</sub>	1.5 V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
VX	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.15 V
VY	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.15 V	V <sub>OH</sub> – 0.15 V

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### **Package Dimensions**

TSSOP48-P-0061-0.50A Unit: mm



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